

S/N: _____

Inventor: Shen Buswell et al

Title: Methods and systems for a forming slots in a semiconductor substrate containing . . .

100

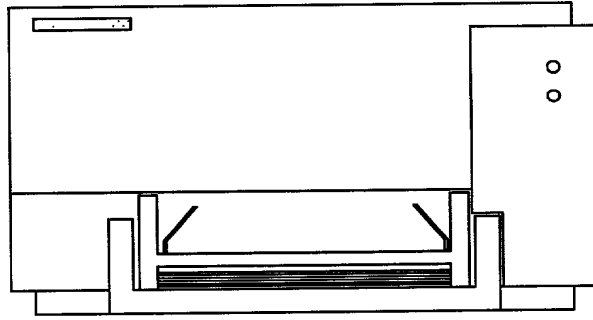


Fig.1

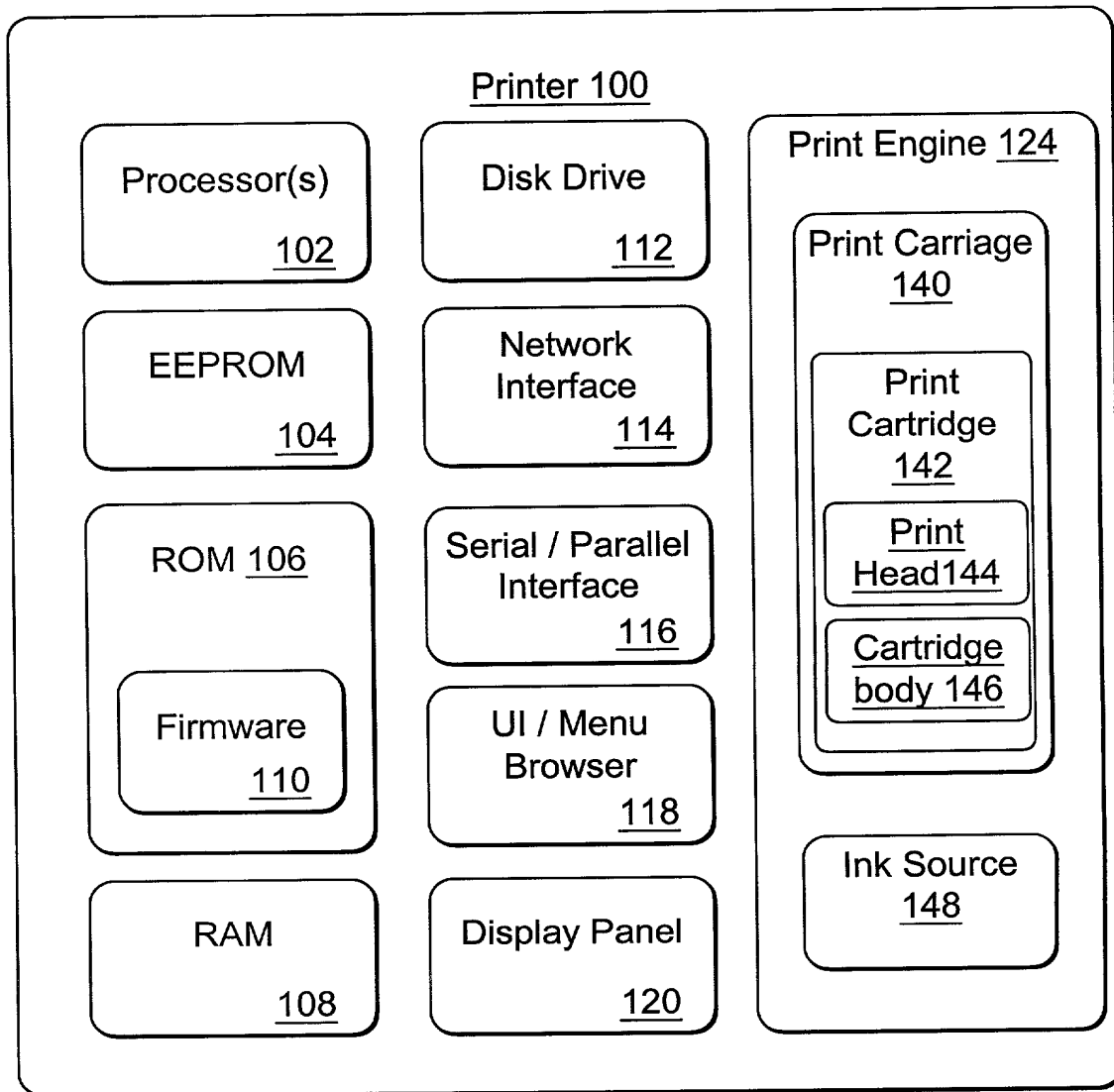


Fig. 2

20110720 14:58:00

S/N: _____

Inventor: Shen Buswell et al

Title: Methods and systems for a forming slots in a semiconductor substrate containing ...

20140226

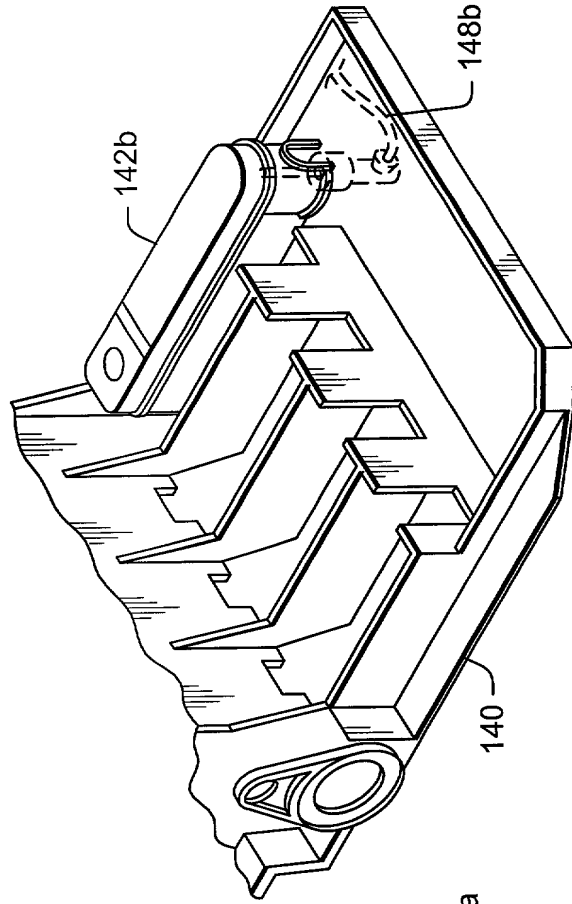


FIG. 3

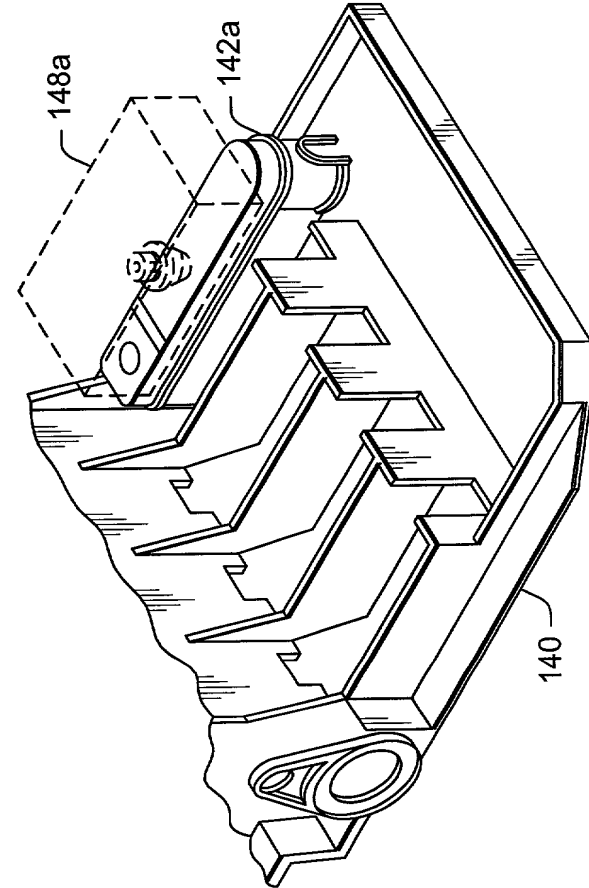


FIG. 4

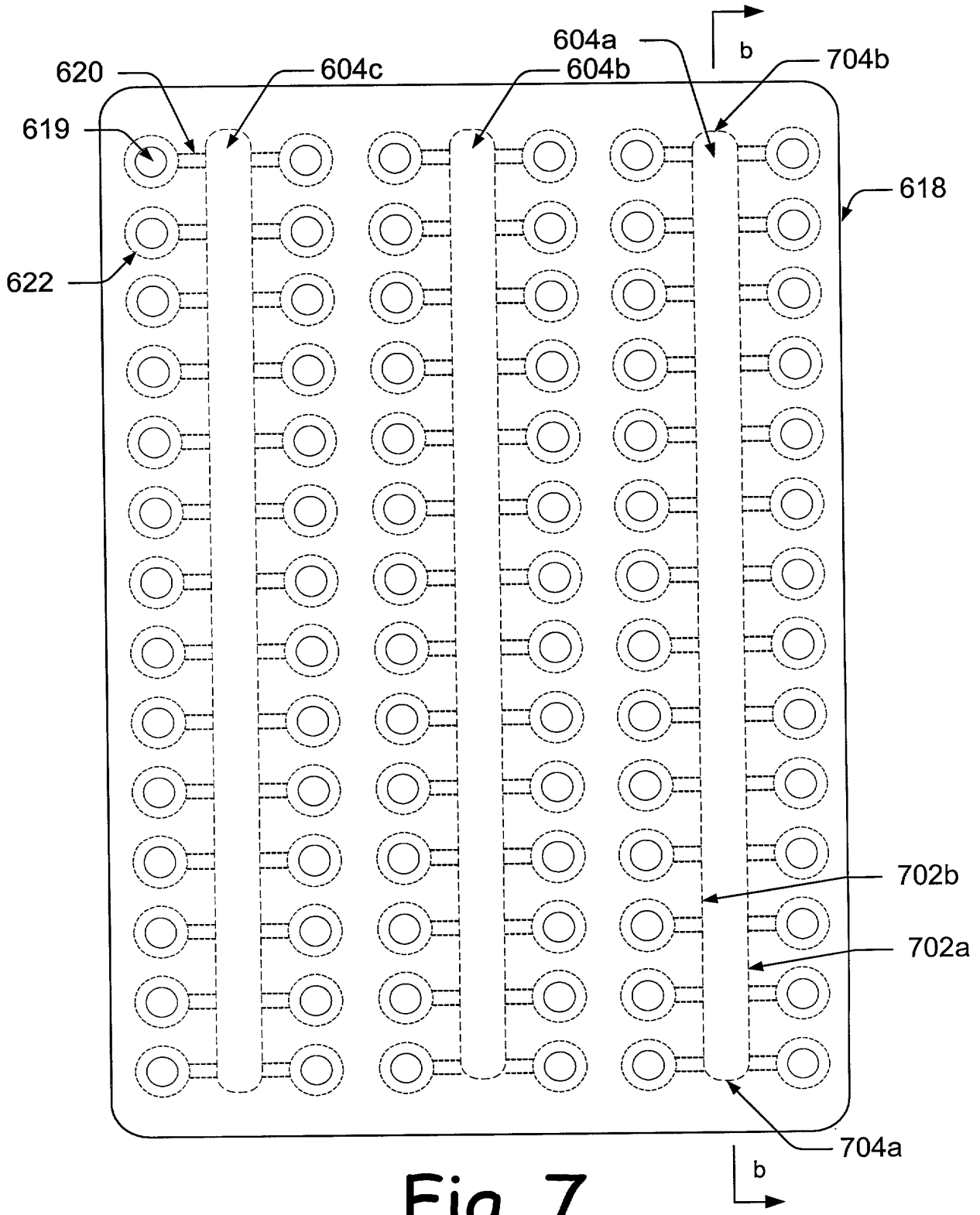


Fig. 7

20250720 14:50:00

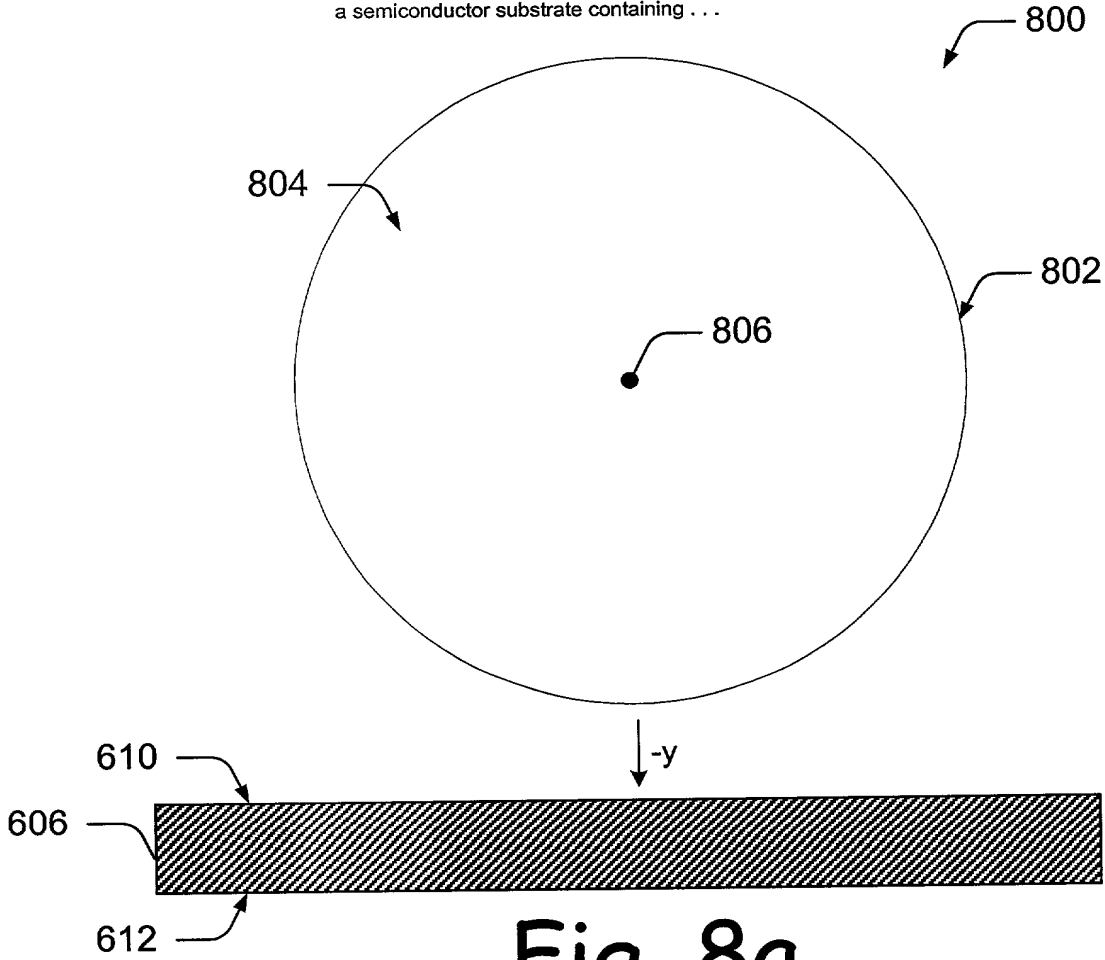


Fig. 8a

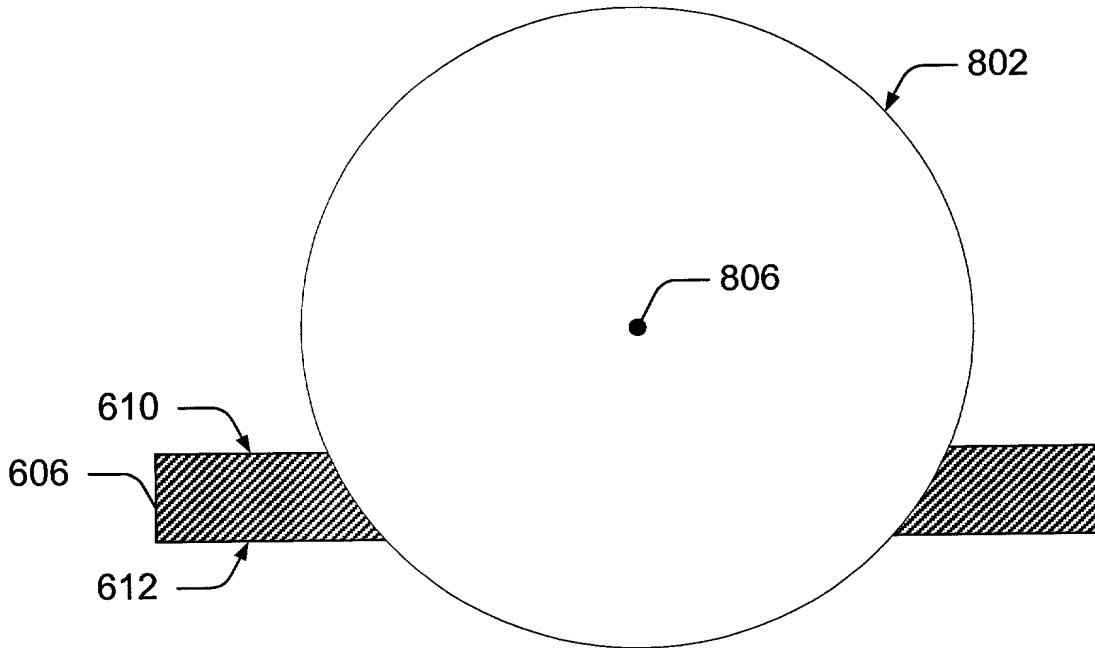


Fig. 8b

2025 RELEASE UNDER E.O. 14176

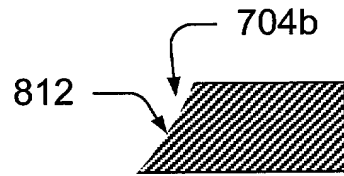
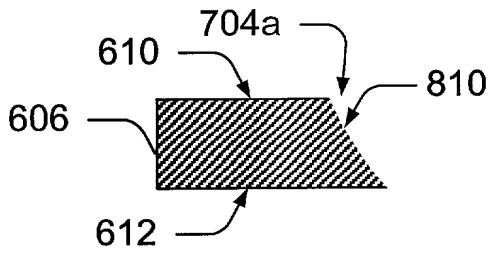


Fig. 8c

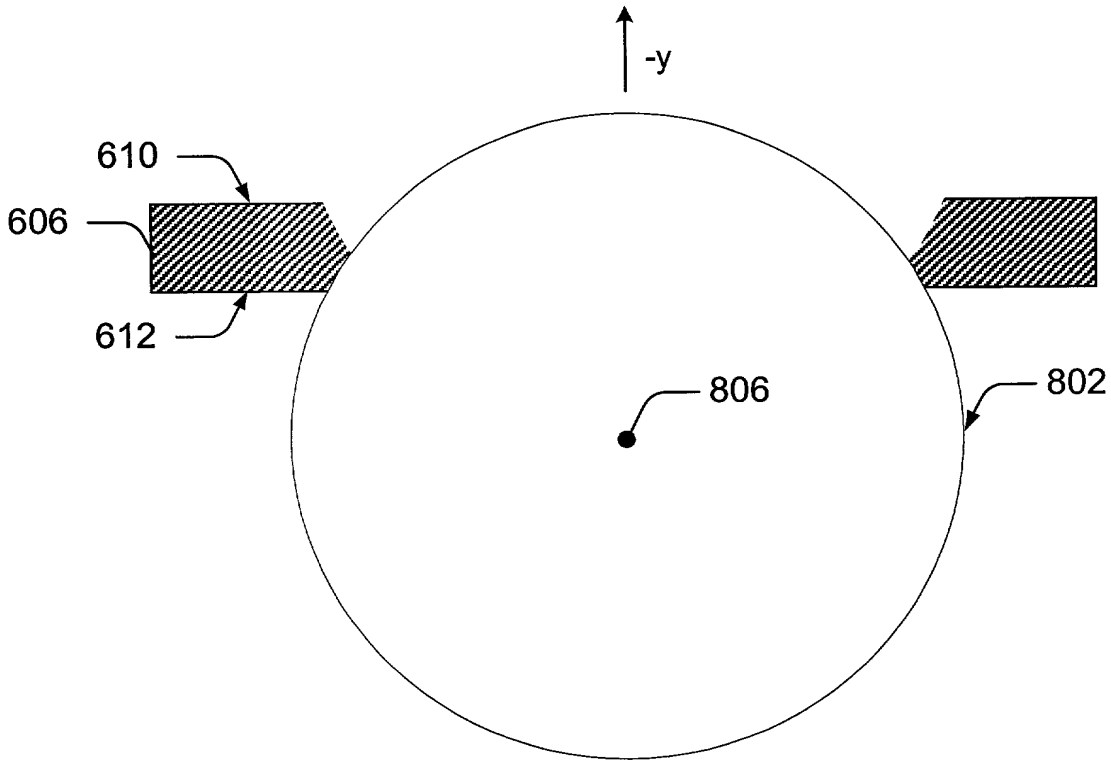


Fig. 8d

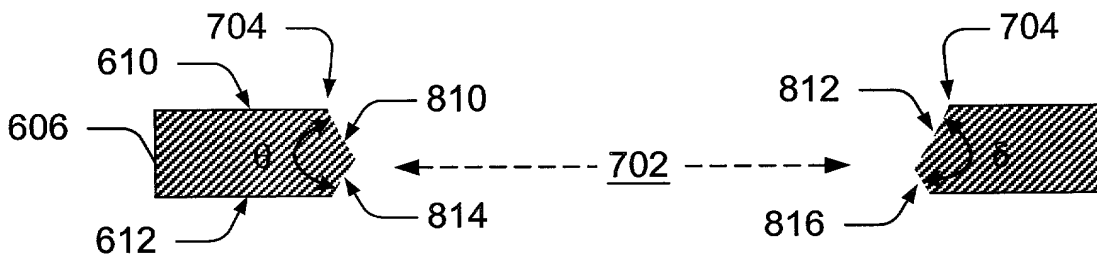


Fig. 8e

20250726 14:54:00

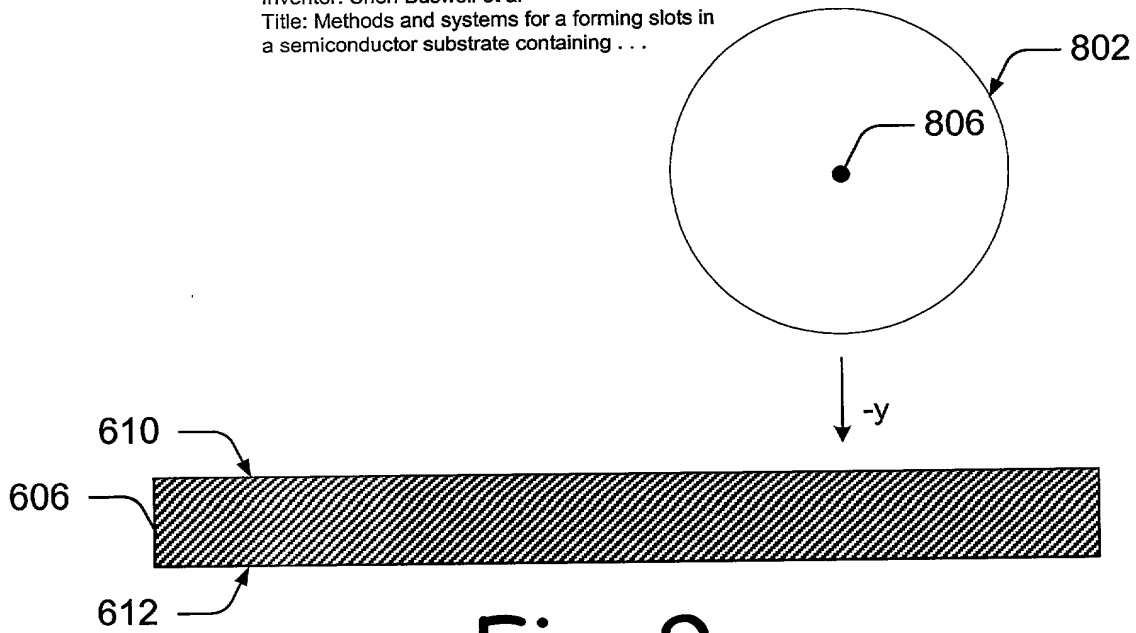


Fig. 9a

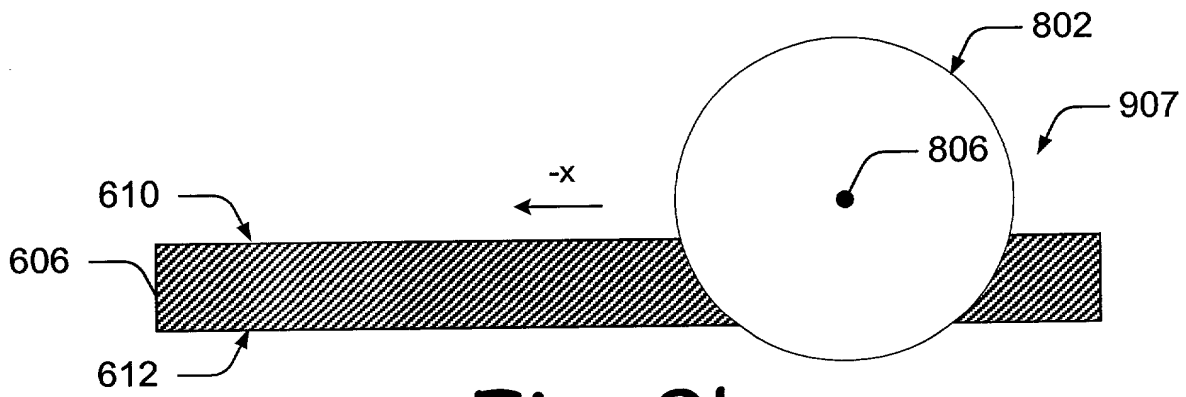


Fig. 9b

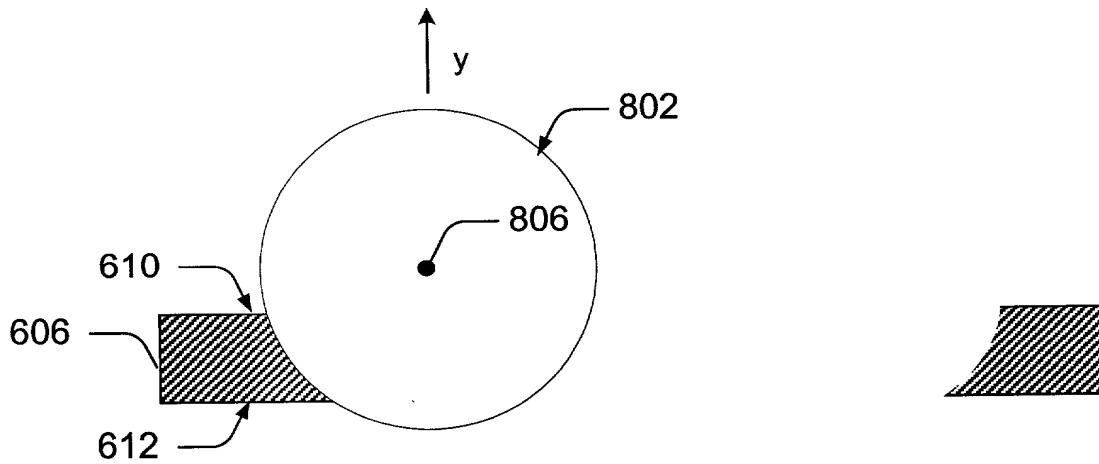


Fig. 9c

20250726 14:54:00

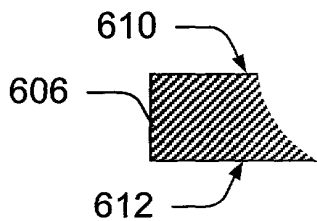


Fig. 9d

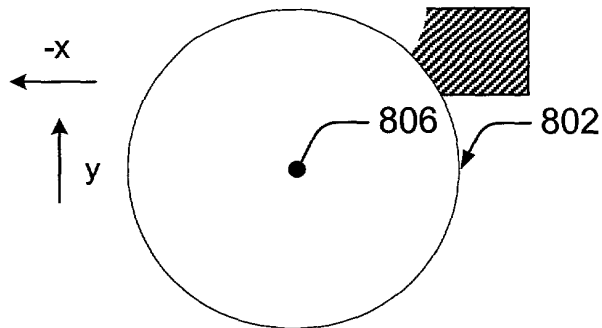
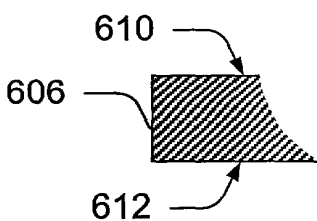


Fig. 9e

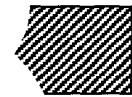
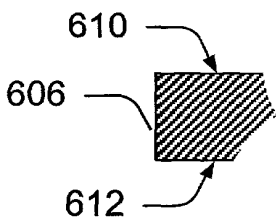


Fig. 9f

20160728

20250719 14:54:49

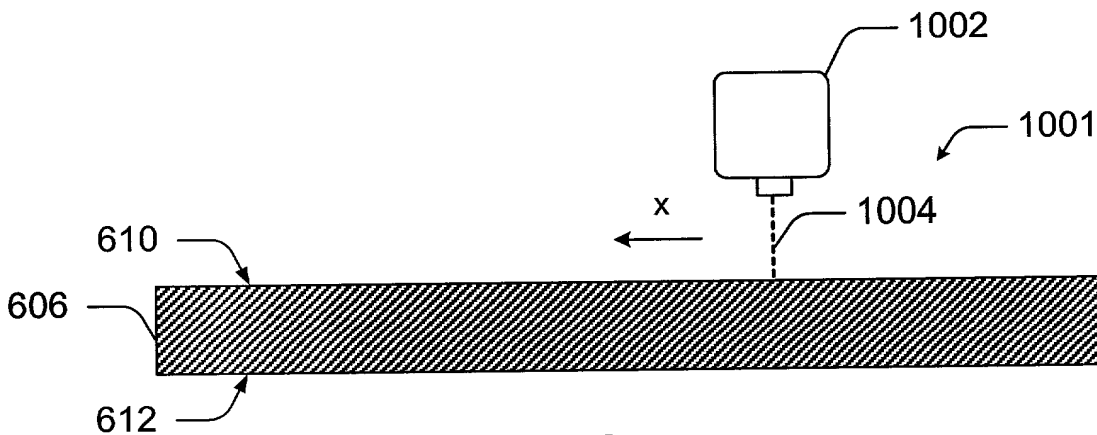


Fig. 10a

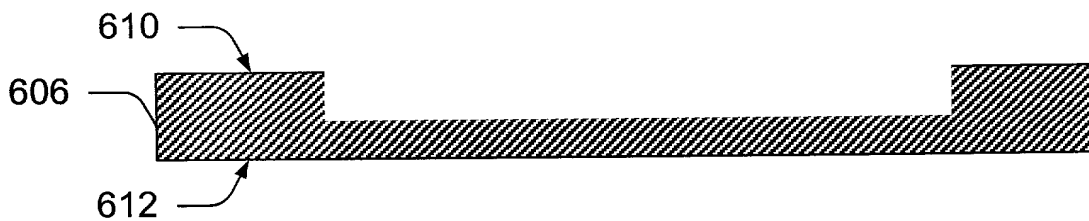


Fig. 10b

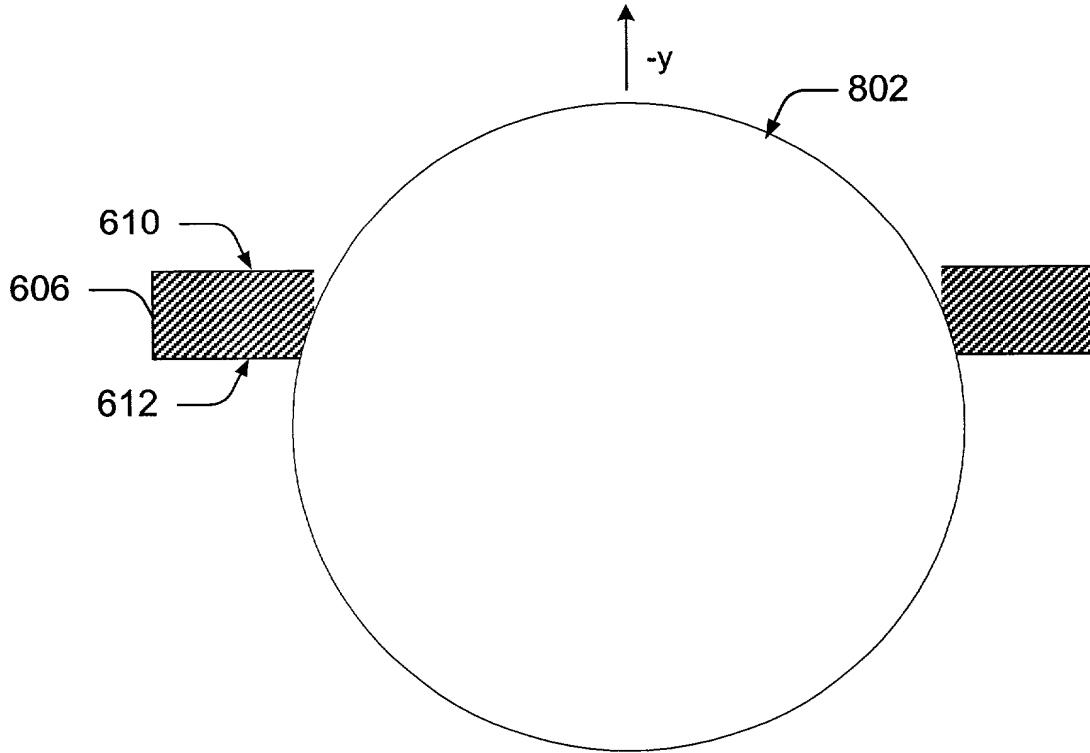


Fig. 10c



Fig. 10d

20250720 14:58:00

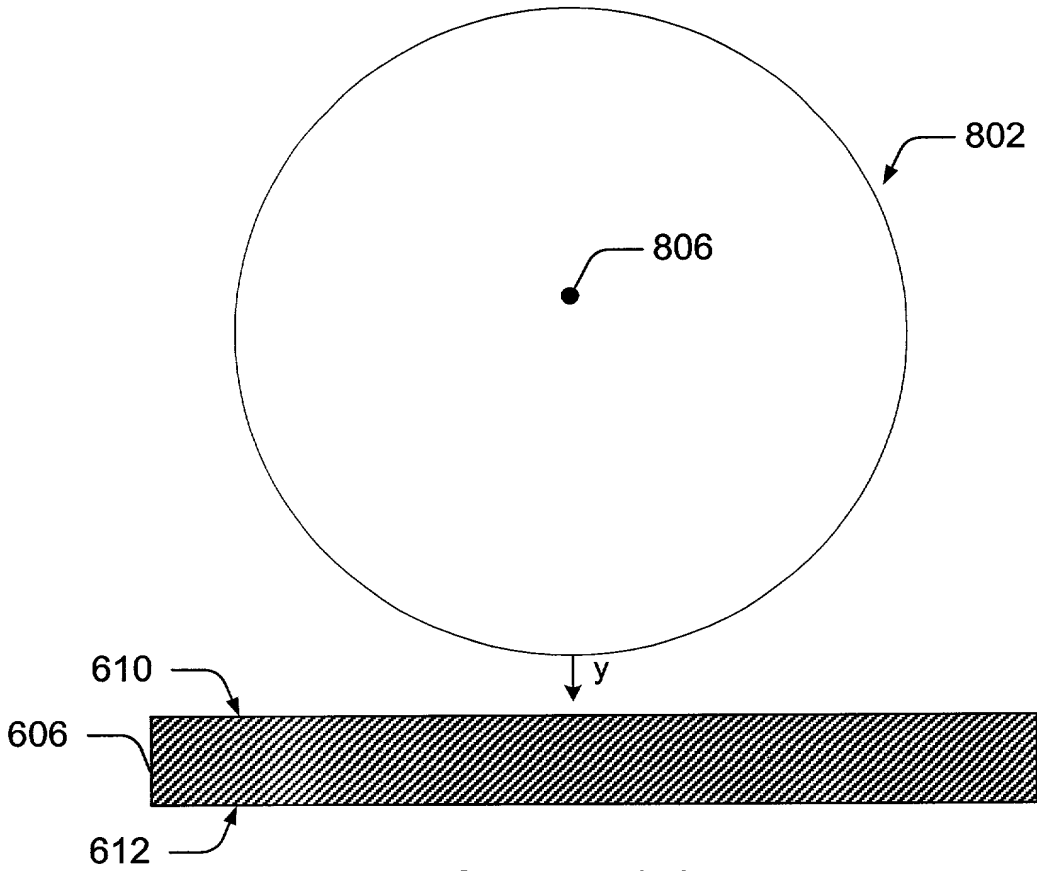


Fig. 11a

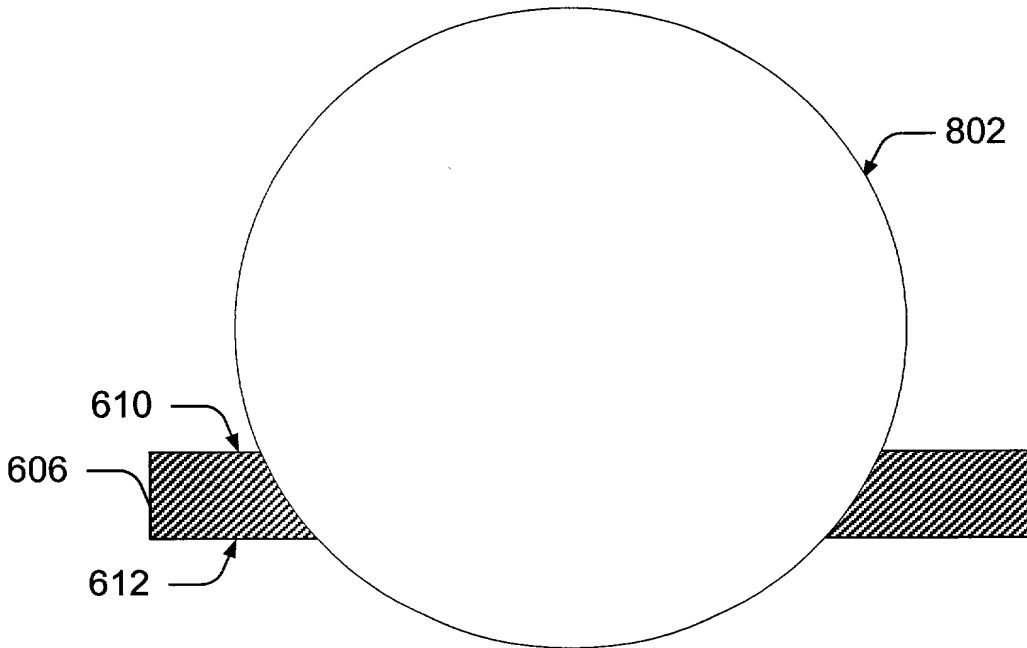


Fig. 11b

20250728 14:59:00

